

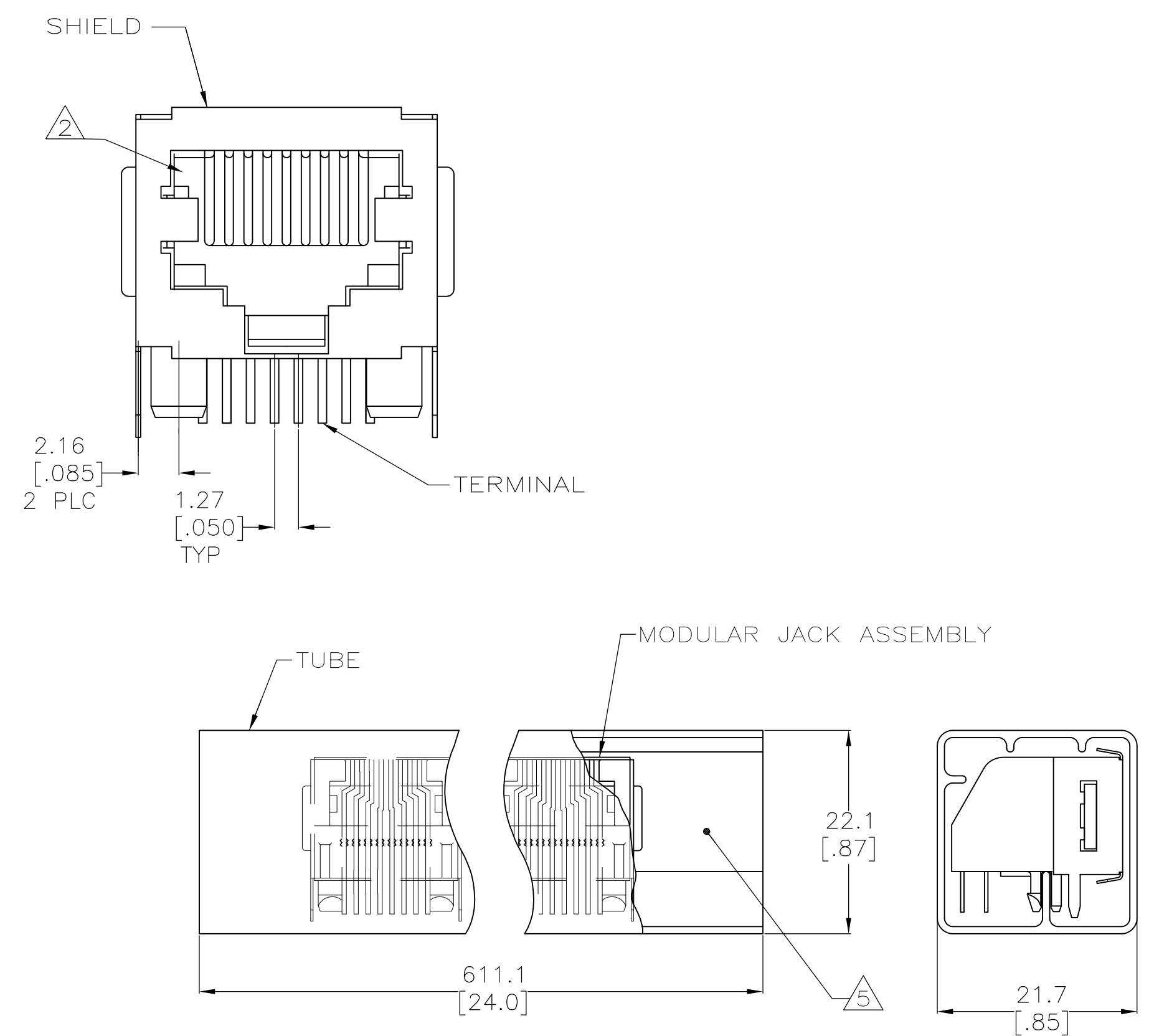
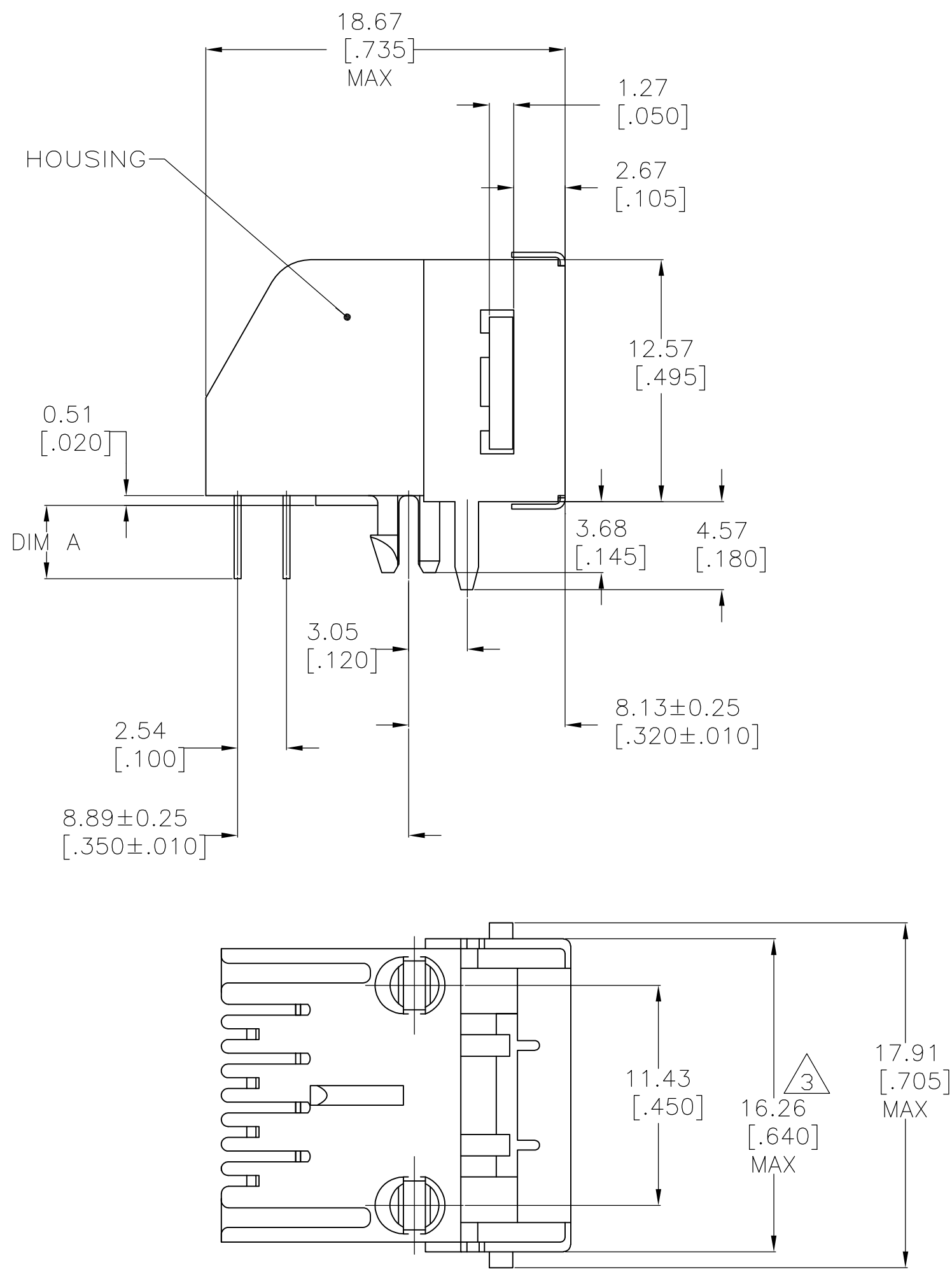
P	LTR	DESCRIPTION	DATE	DWN	APVD
D2		REVISE PER ECO-16-008229	31MAY2016	AD	SH

D

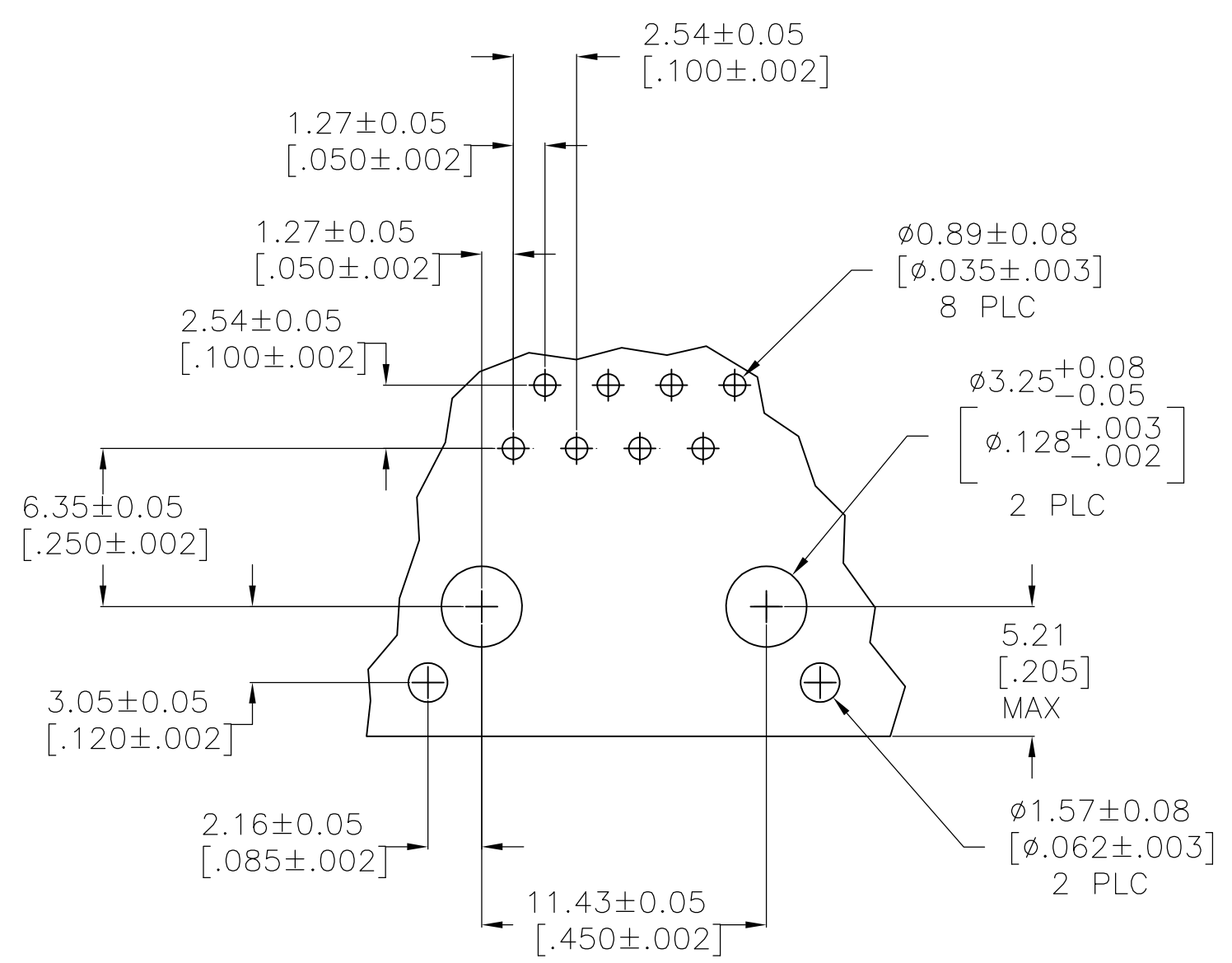
C

B

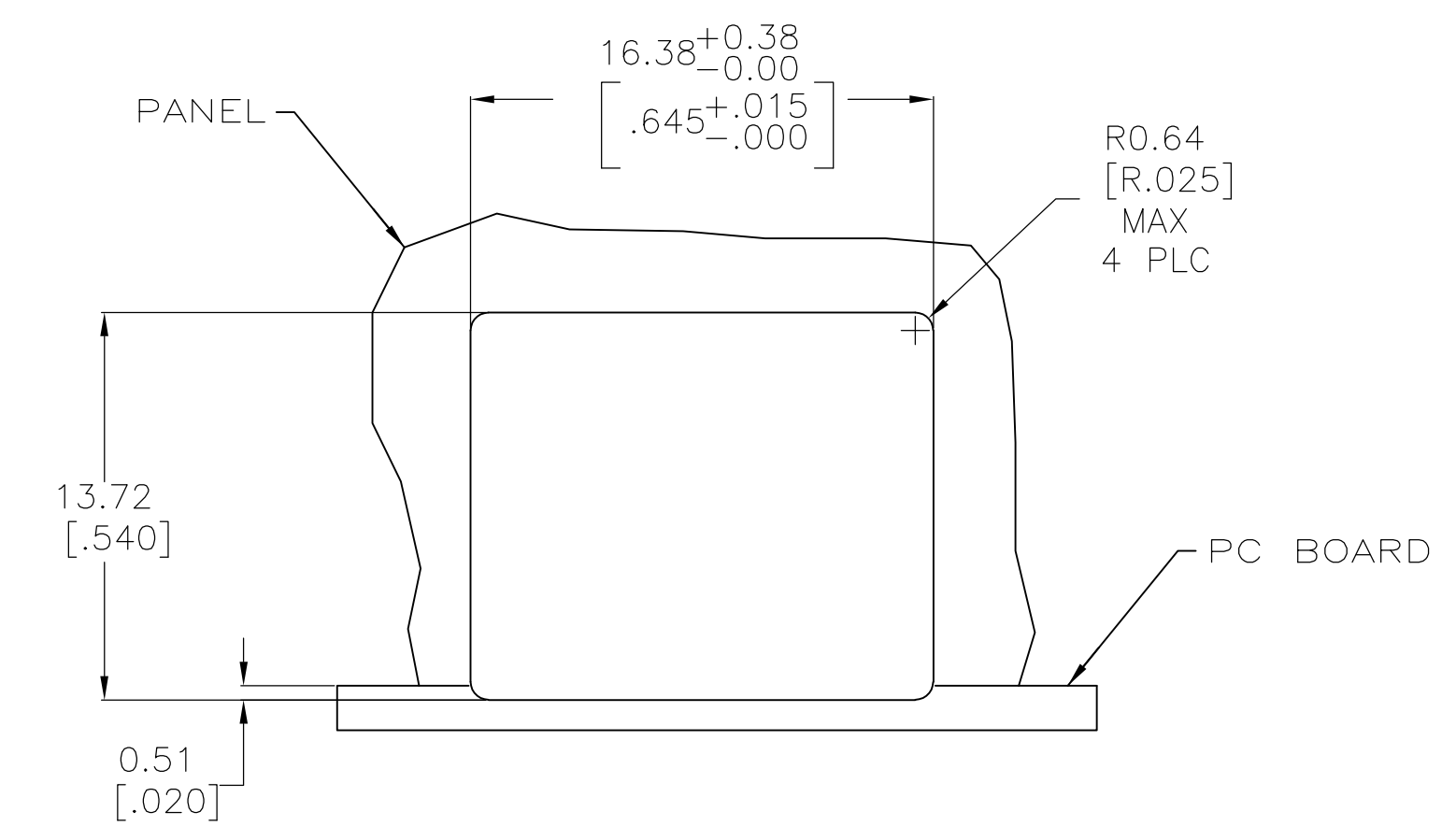
A



DETAIL B
SCALE 2:1



RECOMMENDED PRINTED CIRCUIT BOARD LAYOUT
(COMPONENT SIDE)



RECOMMENDED PANEL CUTOUT

1. MATERIAL:
HOUSING - PBT POLYESTER, COLOR: BLACK
TERMINAL - 0.36[.014] THICK PHOS BRONZE PLATED WITH 1.27µm [.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 2.03µm [.000080] THICK MATTE TIN IN SOLDER AREA OVER 1.27µm [.000050] THICK NICKEL UNDERPLATE
SHIELD - 0.25 [.010] THICK COPPER ALLOY PLATED WITH 3.0µm [.000120] MINIMUM THICK REFLOWED TIN
2. CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
3. DIMENSIONS MEASURED ALONG FRONT EDGES OF MATING FACE
4. BULK PACKAGED IN A TRAY
5. 32 ASSEMBLIES PACKAGED PER TUBE. SEE DETAIL B
6. MATERIAL OF HOUSING:HIGH TEMPERATURE THERMOPLASTIC. COLOR: BALCK

3.30-4.32 [.15±.02]	4	1-5555153-1
1.78-2.79 [.09±.02]	4	5555153-6
2.54-3.05 [.11±.01]	4	5555153-5
3.30-4.32 [.15±.02]	5	5555153-3
3.30-4.32 [.15±.02]	4	5555153-1
DIM A	PACKAGED	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS:
mm [INCHES]

TOLERANCES UNLESS OTHERWISE SPECIFIED:

0' PLC	± .-
1' PLC	± .-
2' PLC	± 0.13[.005]
3' PLC	± .-
4' PLC	± .-
ANGLES	± .-

MATERIAL
SEE NOTE 1

FINISH
SEE NOTE 1

DWN
C. GARRETT/L.A. MAYER

CHK
P. RECCE

APVD
S. FLICKINGER

DATE
05NOV2007

NAME
MODULAR JACK ASSEMBLY,
LOW PROFILE,
PANEL GROUND WITH PANEL STOPS

SIZE
A1

CAGE CODE
00779

DRAWING NO
5555153

RESTRICTED TO
-

TE Connectivity

0000000

CUSTOMER DRAWING

SCALE
4:1

SHEET
1 OF 1

REV
D2